DM5407/DM7407 Hex Buffers with High Voltage Open-Collector Outputs

General Description

This device contains six independent gates each of which performs a buffer function. The open-collector outputs require external pull-up resistors for proper logical operation.

Pull-Up Resistor Equations

$$R_{MAX} = \frac{V_{O} (Min) - V_{OH}}{N_{1} (I_{OH}) + N_{2} (I_{IH})}$$

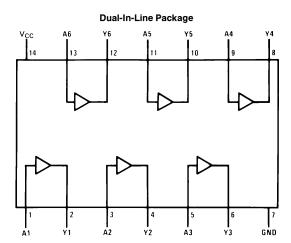
$$R_{MIN} = \frac{V_{O} (Max) - V_{OL}}{I_{OL} - N_{3} (I_{IL})}$$

Where: N_1 (I_{OH}) = total maximum output high current for all outputs tied to pull-up resistor

 $N_2 \; (I_{IH}) = total \; maximum \; input high current for all inputs tied to pull-up resistor$

 $N_3 \ (l_{|L}) = \mbox{total}$ maximum input low current for all inputs tied to pull-up resistor

Connection Diagram



Order Number DM5407J, DM5407W, DM7407M or DM7407N See NS Package Number J14A, M14A, N14A or W14B TL/F/6497-1

Function Table

$\mathbf{Y} = \mathbf{A}$					
Input Output					
Α	Υ				
L	L				
Н	Н				

H = High Logic LevelL = Low Logic Level

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage7VInput Voltage5.5VOutput Voltage30V

Operating Free Air Temperature Range

 DM54
 -55°C to +125°C

 DM74
 0°C to +70°C

 Storage Temperature Range
 -65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM5407			DM7407			Units
		Min	Nom	Max	Min	Nom	Max	Jints
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.8			0.8	V
V _{OH}	High Level Output Voltage			30			30	V
loL	Low Level Output Current			30			40	mA
T _A	Free Air Operating Temperature	-55		125	0		70	°C

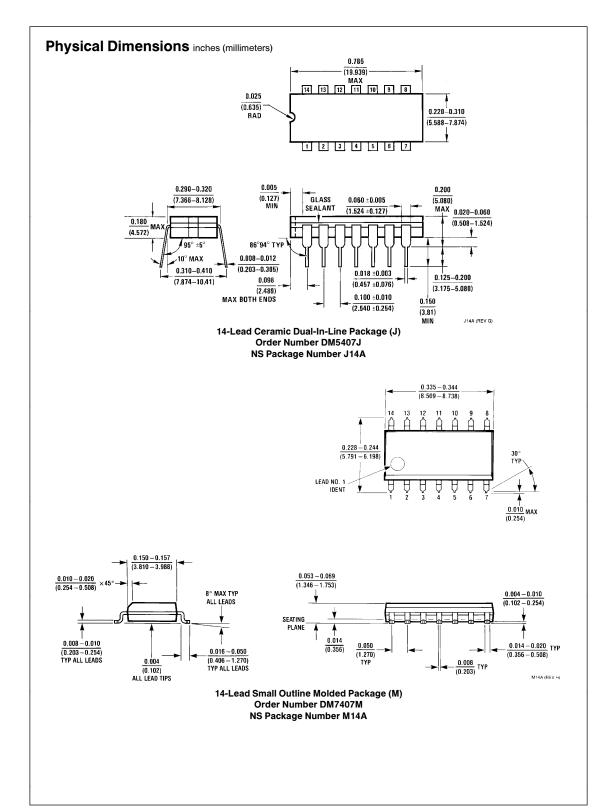
Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions Min		Typ (Note 1)	Max	Units
VI	Input Clamp Voltage	$V_{CC} = Min, I_I = -12 \text{ mA}$			-1.5	V
ICEX	High Level Output Current	$V_{CC} = Min, V_O = 30V$ $V_{IH} = Min$			250	μΑ
V _{OL}	Low Level Output Voltage	$V_{CC} = Min, I_{OL} = Max$ $V_{IL} = Max$			0.7	V
		$I_{OL} = 16 \text{ mA}, V_{CC} = \text{Min}$			0.4	
l _l	Input Current @ Max Input Voltage	$V_{CC} = Max, V_I = 5.5V$			1	mA
I _{IH}	High Level Input Current	$V_{CC} = Max, V_I = 2.4V$			40	μΑ
I _{IL}	Low Level Input Current	$V_{CC} = Max, V_I = 0.4V$			-1.6	mA
Іссн	Supply Current with Outputs High	V _{CC} = Max		29	41	mA
ICCL	Supply Current with Outputs Low	V _{CC} = Max		21	30	mA

$\textbf{Switching Characteristics} \text{ at V}_{CC} = 5 \text{V and T}_{A} = 25^{\circ}\text{C (See Section 1 for Test Waveforms and Output Load)}$

Symbol	Parameter	Conditions	Min	Max	Units
t _{PLH}	Propagation Delay Time Low to High Level Output	$C_L = 15 pF$ $R_L = 110\Omega$		10	ns
t _{PHL}	Propagation Delay Time High to Low Level Output			30	ns

Note 1: All typicals are at $V_{CC} = 5V$, $T_A = 25$ °C.



Physical Dimensions inches (millimeters) (Continued) 14 13 12 14 13 12 11 10 9 1 2 3 4 5 6 7 0.092 (2.337) DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.065

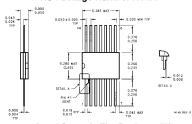
 $\frac{0.125 - 0.150}{(3.175 - 3.810)}$ 0.014 - 0.023 (0.356 - 0.584) TYP

14-Lead Molded Dual-In-Line Package (N) Order Number DM7407N NS Package Number N14A

0.100 ± 0.010 (2.540 ± 0.254)

 $0.325 \begin{array}{l} +0.04 \\ -0.01 \end{array}$ (8.255 + 1.016 - 0.381

 $\frac{0.050\pm0.010}{(1.270-0.254)}$ TYP



14-Lead Ceramic Flat Package (W) Order Number DM5407W NS Package Number W14B

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